



Note: components designated with "_X_" do not have places on PCB

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Orderable: EVM_orderable	Designed for: Public Release	Mod. Date: 4/25/2018
TID #: N/A	Project Title: LM5022 Isolated Flyback	
Number: PMP20468	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: PMP20468.SchDoc	Size: B
Engineer: J Doong	Contact: http://www.ti.com/support	





IPCB
PCB: PMP9648 REVA
 PMP9648 REVA

Variant/Label Table	
Variant	Label Text
001	

LBL1
PCB Label
 Size: 0.65" x 0.20 "

ZZ1
Label Assembly Note
 This Assembly Note is for PCB labels only

ZZ2
Assembly Note
 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: EVM_orderable	Designed for: Public Release	Mod. Date: 8/31/2016
TID #: N/A	Project Title: LM5022 Isolated Flyback	
Number: PMP20468	Rev: A	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3
Drawn By:	File: PMP20468_Hardware.SchDoc	Size: B
Engineer: J Doong	Contact: http://www.ti.com/support	



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